

ESD3V3AP

Description

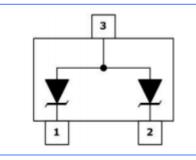
ESD3V3AP is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

Features

- Ultra low leakage
- Operating voltage: 3.3V
- Package: SOT-23
- Protects one bidirectional line or two unidirectional
- Low clamping voltage
- Complies with following standards:
- IEC 61000-4-2 (ESD) immunity test
 Air discharge: ±15kV
 Contact discharge: ±8kV
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning) 5A (8/20µs)



Functional Diagram



Applications

- Portable Electronics
- Cellular Handsets and Accessories
- Industrial Controls
- Portable instrumentation
- Set-Top Box
- Peripherals

Absolute Maximum Ratings(Tamb=25 °C unless otherwise specified)

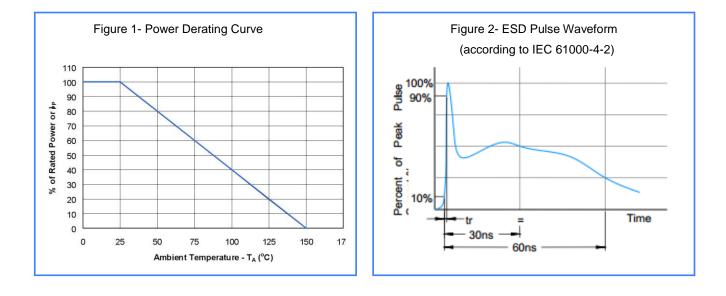
Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	P _{PP}	300	Watts	
ESD per IEC 61000-4-2 (Air)	N/	±15	KV	
ESD per IEC 61000-4-2 (Contact)	V _{ESD}	±8	KV	
Lead Soldering Temperature	TL	260 (10 sec)	°C	
Operating Temperature Range	TJ	-55 to +150	°C	
Storage Temperature Range	T _{STJ}	-55 to +150	°C	



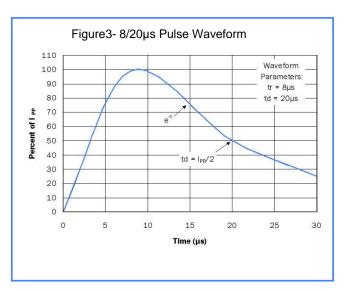
Electrical Characteristics (TA = 25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Reverse Stand-off Voltage	VRWM				3.3	V
Reverse Breakdown Voltage	VBR	lt = 1mA	5		5.9	V
Reverse Leakage Current	IR	VR =VRWM			10	μΑ
Clamping Voltage	VC	@IPP			9.3	V
Junction Capacitance	CJ	VR=0V, f = 1MHz		150		pF

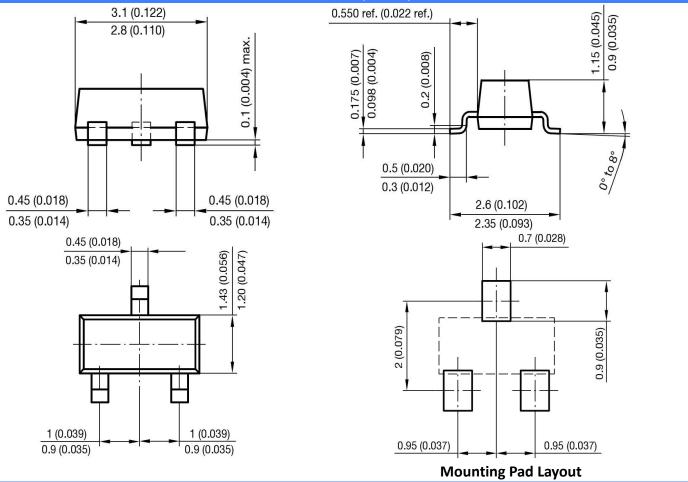
Characteristics Curves











Disclaimer

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.